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Lee et al.

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(54) **SUBSTRATE TRANSFER DEVICE FOR SEMICONDUCTOR DEPOSITION APPARATUS**

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(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (9) Cl.** **13-03**

(52) **U.S. Cl.** **D13/182**

(58) **Field of Classification Search** D13/182;
134/110; 361/234; 396/611; 414/331.15,
414/411, 416.03; 700/213

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a substrate transfer device for semiconductor deposition apparatus, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a substrate transfer device that may be positioned in a semiconductor deposition apparatus, showing our new design;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a rear elevation view thereof;

FIG. 4 is a left side elevation view thereof;

FIG. 5 is a right side elevation view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

The ornamental design which is claimed is shown in solid lines in the drawings.

1 Claim, 5 Drawing Sheets

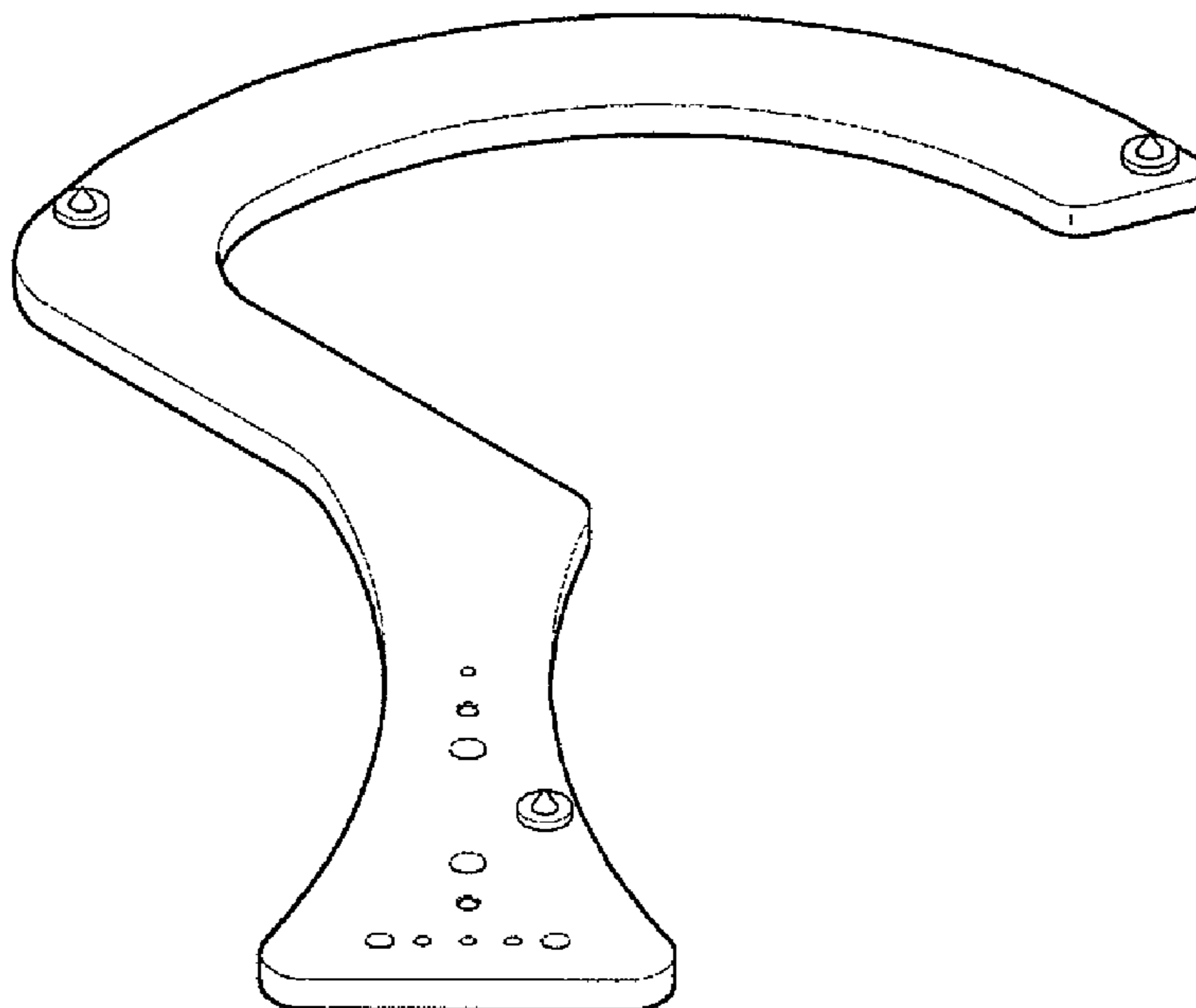


FIG. 1

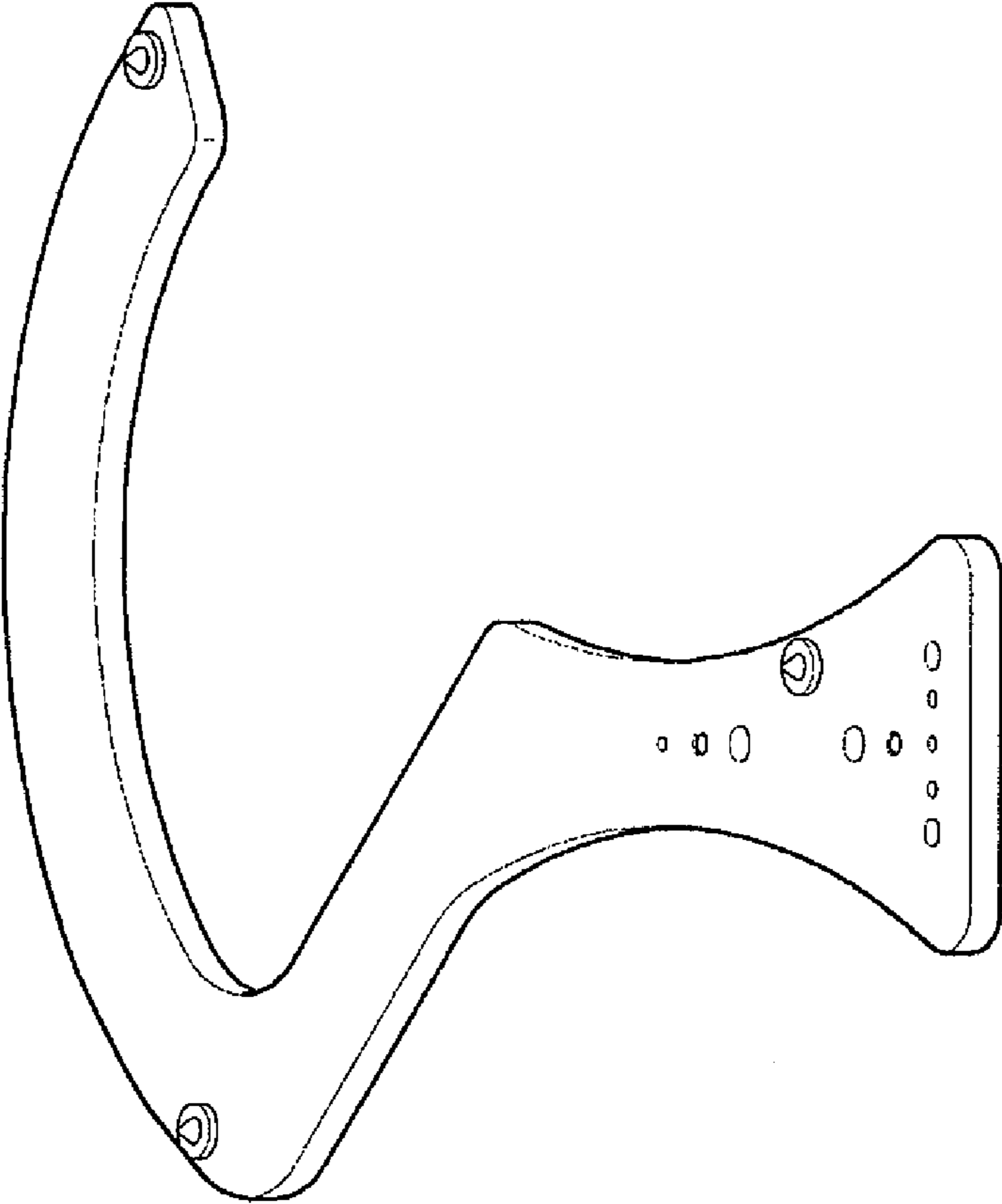


FIG. 2

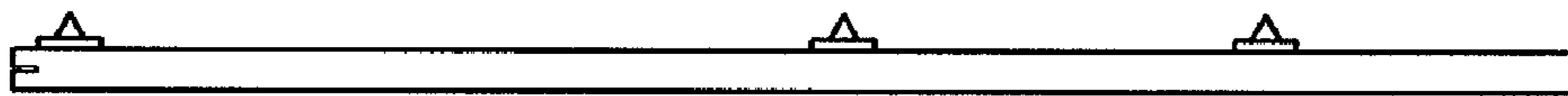


FIG. 3



FIG. 4

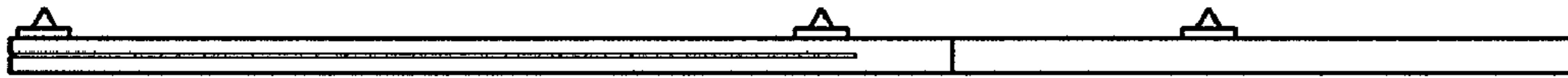


FIG. 5



FIG. 6

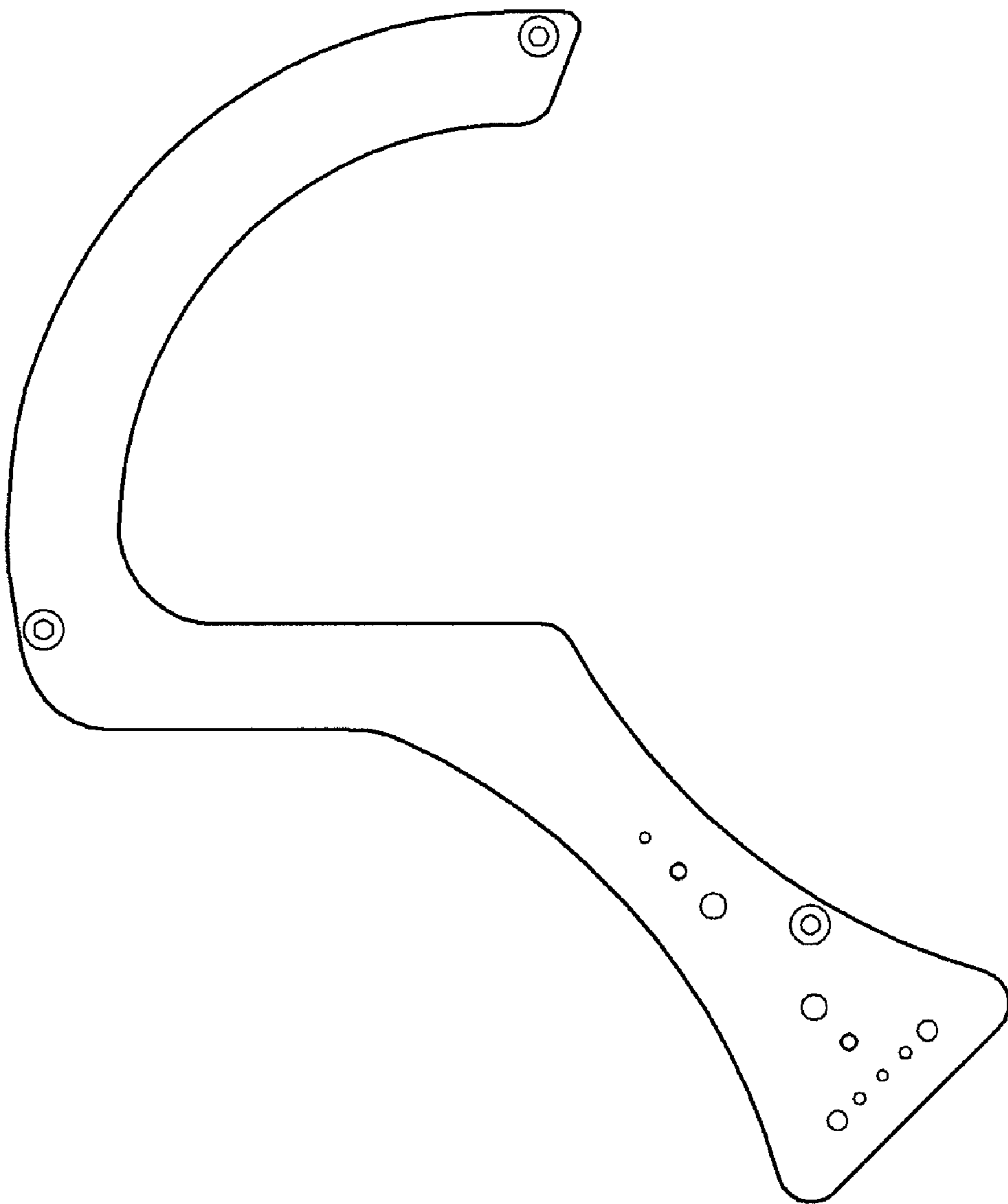


FIG. 7

